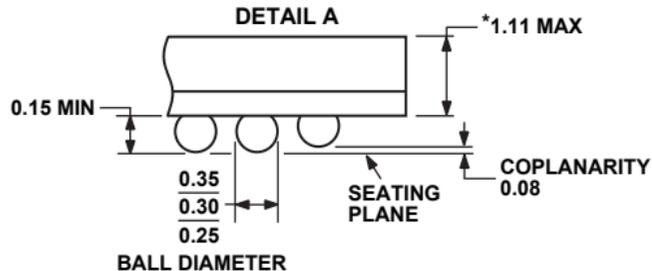
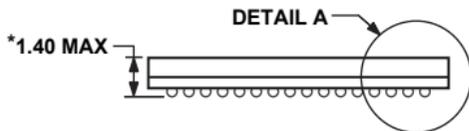
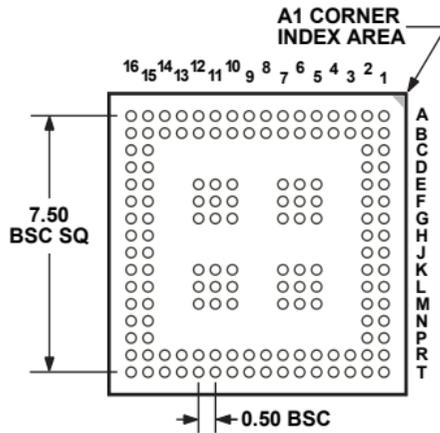
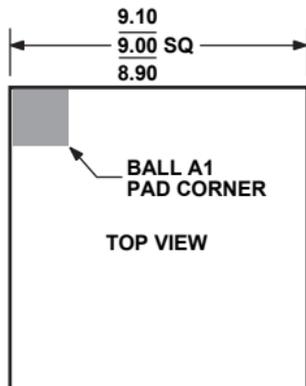


**148-Ball Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-148)**

Dimensions shown in millimeters



*COMPLIANT TO JEDEC STANDARDS MO-195 WITH EXCEPTION
TO DIMENSIONS PACKAGE HEIGHT AND THICKNESS.